**URL** for Additional Information

PART INFORMATION

Mfg Item Number

Mfg Item Name

MC8640DTVU1000HE

FCCBGA 1023 33SQ\*1.2P1.0

SUPPLIER Company Name Freescale Semiconductor Inc Company Unique ID 14-141-7928 Response Date 2015-12-10 Response Document ID 8411K11156D013M1.2 Contact Name Freescale Semiconductor Inc Contact Title Product Technical Support **Contact Phone** 1-800-521-6274 Contact Email support@freescale.com Daniel Binyon **Authorized Representative** Representative Title **EPP Customer Response** Representative Phone 512-895-3406 Representative Email eppanlst@freescale.com

www.freescale.com

MANUFACTURING Mfg Item Number MC8640DTVU1000HE FCCBGA 1023 33SQ\*1.2P1.0 Mfg Item Name Version ALL Weight 5.462500 UoM Unit Volume EACH J-STD-020 MSL Rating 3 Peak Processing Temperature 245 C Max Time at Peak Temperature 30 seconds Number of Processing Cycles 3

2011/65/EU **RoHS Directive** RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material of Cadmium **RoHS Definition** Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part(s) identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a RoHS restricted substance) in excess of the applicable quantity limit identified below. If a homogeneous material within the part(s) contains a RoHS restricted substance in excess **RoHS Legal Definition** restricted substance) in excess of the applicable quantity limit identified below. If a homogeneous material within the part(s) contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Suppliers liability and the Companys remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Suppliers Standard Terms and Conditions of Sale applicable to such part(s) shall apply. Sale applicable to such part(s) shall apply. **RoHS Declaration** 4 - Item(s) does not contain RoHS restricted substances per the definition above except for selected exemptions Accepted Supplier Acceptance Signature **Daniel Binyon Exemption List Version** 2012/51/EU Exemptions in this part 15:Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages List of Freescale Accepted Exemptions 6(a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight 6(b): Lead as an alloying element in aluminium containing up to 0.4% lead by weight 6(c): Copper alloy containing up to 4% lead by weight 7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead) 7(b) : Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission, and network management for 7(c)-I: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound 7(c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher 7(c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC

7(c)-IV: Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors

15 : Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages

Capacitor, 0306   0,1462   Noted   Copper, metal   Copper, metal   7440-50-8   0,0201766   0, 13800   13.8   5083   0,3683   0,	5219 3347 7503 30048 30293 30432 36532 6659 568 41192 2486
Capacitor, 0306   Nickel (external applications only)   Nickel   7440-02-0   0.028509   9   195000   19.5   5219   0.5219	5219 3347 7503 30048 30293 30432 36532 6659 568 41192 2486
Capacitor, 0.006   Metals   Metals   Tin, metal   Tin,	0347 7503 0048 00293 0432 0659 668 4192
Capacitor, 0306   Metals   Metals   Barium titanate   12047-27.7   0.0966148   0.66400   65.4   17503   1.750	7503 0048 00293 0432 0532 6659 668 4192
Capacitor Solder Paste         0.0634         Metals         Copper, metal         7440-67-8         0.000267         g         600         0.5         48         0.008           Capacitor Solder Paste         1         Metals         Copper, metal         7440-67-8         0.000267         g         6000         0.5         48         0.008           Capacitor Solder Paste         1         Metals         Silver, metal         7440-22-4         0.001602         g         30000         3         293         0.023           Capacitor Solder Paste         1         Metals         Tin, metal         7440-21-5         0.001602         g         30000         3         293         0.023           Capacitor Solder Paste         9         Metals         1         Metals         1         0.01602         g         30000         3         293         0.023           Capacitor Solder Paste         9         Metals         1         Metals         1         0.01602         g         30000         3         3         9         0.932           Ceramic Substrate         1         Metals         Aluminum Oxides (AI203)         1344-28-1         0.0166696         g         2720         2722         19532	0048 0293 9432 9532 6659 668 4192
Capacitor Solder Paste         Metals         Copper, metal         7440-50-8         0.000267         g         5000         0.5         48         0.048           Capacitor Solder Paste         Lead/Lead Compounds         Lead         7439-92-1         0.00000443         g         83         0.0083         0         0         0           Capacitor Solder Paste         Metals         Silver, metal         7440-22-4         0.001602         g         3000         3         293         0.023           Capacitor Solder Paste         Metals         Silver, metal         7440-22-4         0.001602         g         96917         96917         9533         0.293           Capacitor Solder Paste         Metals         Metals         Tim, metal         7440-31-5         0.05152857         g         96917         96917         9432         0.933           Ceramic Substrate         3,918         Image: metal of the companies of the compa	0293 9432 9532 .669 568 4192
Capacitor Solder Paste         Lead/Lead Compounds         Lead         7439-92-1         0,0000443         g         83         0,0083         0         0           Capacitor Solder Paste         Metals         Silver, metal         7440-22-4         0,001602         g         30000         3         293         0,0293           Capacitor Solder Paste         Metals         Metals         Tin, metal         7440-31-5         0,0156267         g         964917         96.917         9432         0,932           Ceramic Substrate         3,918         Metals         Aluminum Oxides (AIZO3)         134-28-1         0,10669966         g         27220         2722         19532         1,9532           Ceramic Substrate         Metals         Barium oxide         1304-28-5         0,63687342         g         162476         16,2476         116590         11,659           Ceramic Substrate         Metals         Boron oxide         1303-86-2         0,1402818         g         3,5788         3,5788         25680         2,588           Ceramic Substrate         Metals         Chromium oxide         1305-78-8         0,0775258         g         19778         1,1978         1,192         1,4192         1,4192           Ceramic Substra	0293 9432 9532 .669 568 4192
Capacitor Solder Paste	9432 9532 .669 568 4192 2486
Capacitor Solder Paste         Metals         Tin, metal         7440-31-5         0.05152657         g         964917         964917         9432         0.9432           Ceramic Substrate         3.9198         Metals         Aluminum Oxides (Al2O3)         1344-28-1         0.1066966         g         27220         2.722         19532         1.9532         1.9532           Ceramic Substrate         Metals         Barium oxide         1304-28-5         0.63887342         g         162476         16.2476         116590         11.659           Ceramic Substrate         Metals         Boron oxide         1303-88-2         0.1402818         g         35788         3.5788         25680         2.568           Ceramic Substrate         Solvents, additives, and other materials         Calcium monoxide         1305-78-8         0.0775258         g         1476         1.1778         1.14192         1.4192	9432 9532 .669 568 4192 2486
Ceramic Substrate         3.9198         Metals         Aluminum Oxides (AI2O3)         1344-28-1         0.1066996         g         27220         2.722         19532         1.953	9532 .659 .668 4192 2486
Ceramic Substrate         Metals         Aluminum Oxides (Al2O3)         1344-28-1         0.10669696         g         27220         2.722         19532         1.9532           Ceramic Substrate         Metals         Barium oxide         1304-28-5         0.63687342         g         162476         16.2476         116590         11.659           Ceramic Substrate         Metals         Boron oxide         1303-86-2         0.1402818         g         35788         3.5788         25680         2.568           Ceramic Substrate         Solvents, additives, and other materials         Calcium monoxide         1305-78-8         0.0775258         g         19778         1,9778         14192         1.4192           Ceramic Substrate         Metals         Chromium oxide         1308-38-9         0.01358211         g         3465         0.3465         2486         0.2486           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.00297         g         586         0.0586         420         0.042	.659 568 4192 2486
Ceramic Substrate         Metals         Barium oxide         1304-28-5         0.63687342         g         162476         16.2476         116590         11.659           Ceramic Substrate         Metals         Boron oxide         1303-86-2         0.1402818         g         35788         3.5788         25680         2.568           Ceramic Substrate         Solvents, additives, and other materials         Calcium monoxide         1305-78-8         0.0775258         g         19778         1,9778         14192         1,4192           Ceramic Substrate         Metals         Chromium oxide         1308-38-9         0.01358211         g         3465         0.3465         2486         0.2486           Ceramic Substrate         Metals         Copper, metal         7440-50-8         0.49623492         g         126597         12.6597         90843         9.0843           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.00297         g         586         0.0586         420         0.042	.659 568 4192 2486
Ceramic Substrate         Metals         Boron oxide         1303-86-2         0.1402818         g         35788         3.5788         25680         2.568           Ceramic Substrate         Solvents, additives, and other materials         Calcium monoxide         1305-78-8         0.0775258         g         19778         1,9778         14192         1,4192         1,4192           Ceramic Substrate         Metals         Chromium oxide         1308-38-9         0.01358211         g         3465         0.3465         2486         0.2486           Ceramic Substrate         Metals         Copper, metal         7440-50-8         0.49623492         g         126597         12.6597         90843         9.0843           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	568 4192 2486
Ceramic Substrate         Solvents, additives, and other materials         Calcium monoxide         1305-78-8         0.0775258         g         19778         1.9778         14192         1.4192           Ceramic Substrate         Metals         Chromium oxide         1308-38-9         0.01358211         g         3465         0.3465         2486         0.2486           Ceramic Substrate         Metals         Copper, metal         7440-50-8         0.49623492         g         126597         12.6597         90843         9.0843           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	4192 2486
Ceramic Substrate         Metals         Chromium oxide         1308-38-9         0.01358211         g         3465         0.3465         2486         0.2486           Ceramic Substrate         Metals         Copper, metal         7440-50-8         0.49623492         g         126597         12.6597         90843         9.0843           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	2486
Ceramic Substrate         Metals         Copper, metal         7440-50-8         0.49623492         g         126597         12.6597         90843         9.0843           Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	
Ceramic Substrate         Metals         Cuprous oxide         1317-39-1         0.00313584         g         800         0.08         574         0.0574           Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	0.40
Ceramic Substrate         Metals         Gold, metal         7440-57-5         0.002297         g         586         0.0586         420         0.042	843
	574
Ceramic Substrate Solvents, additives, and other materials Phosphorus, elemental (not containing red allotrone) 7723-14-0 0.0156792 g 400 0.04	142
Out of the first o	287
Ceramic Substrate         Lead/Lead Compounds         Lead         7439-92-1         0.00001176         g         3         0.0003         2         0.0002	002
Ceramic Substrate         Metals         Magnesium-oxide         1309-48-4         0.00313584         g         800         0.08         574         0.0574	574
Ceramic Substrate         Nickel (external applications only)         Nickel         7440-02-0         0.01587911         g         4051         0.4051         2906         0.2906	906
Ceramic Substrate         Metals         Palladium, metal         7440-05-3         0.0019599         g         50         0.005         35         0.0035	035
Ceramic Substrate         Glass         Silicon dioxide         7631-86-9         2.34703513         g         59.8764         59.8764         42.9686         42.9686	.9686
Ceramic Substrate         Metals         Strontium Oxide         1314-11-0         0.00837269         g         2136         0.2136         1532         0.1532	532
Ceramic Substrate         Metals         Titanium (IV) Oxide         13463-67-7         0.0006272         g         16         0.0016         11         0.0011	011
Ceramic Substrate         Metals         Zinc oxide         1314-13-2         0.0005096         g         13         0.0013         9         0.0009	009
Ceramic Substrate         Metals         Ziroonium oxide         1314-23-4         0.0668603         g         17057         1.7057         12239         1.2239	239
Solder Balls - Pb Free, Sn/Ag         0.8377         g         g	
Solder Balls - Pb Free, Sn/Ag         Metals         Silver, metal         7440-22-4         0.0293195         g         35000         3.5         5367         0.5367	367
Solder Balls - Pb Free, Sn/Ag         Metals         Tin, metal         7440-31-5         0.8083805         g         965000         96.5         147987         14.7987	.7987
Solder Paste         0.0855         g	
Solder Paste Solvents, additives, and other materials Proprietary Material-Other aromatic amines - 0.00211219 g 24704 2.4704 386 0.0386	J <mark>386</mark>
Solder Paste         Metals         Copper, metal         7440-50-8         0.00052805         g         6176         0.6176         96         0.0096	1096
Solder Paste Solvents, additives, and other materials Other organic compounds 0.00364239 g 42601 4.2601 666 0.0666	l <mark>666</mark>
Solder Paste         Metals         Silver, metal         7440-22-4         0.00286656         g         33527         3.3527         524         0.0524	524
Solder Paste         Metals         Tin, metal         7440-31-5         0.07204024         g         84.2576         84.2576         13188         1.3188	188
Solder Paste Solvents, additives, and other materials Poly(ethylene glycol-ran-propylene glycol) monobutyl 9038-95-3 0.00431057 g 50416 5.0416 789 0.0789	789
Underfill 0.0726 g g	
Underfill         Plastics/polymers         Proprietary Material-Other Epoxy resins         -         0.01452         g         200000         20         2658         0.2658	2658
Underfill Solvents, additives, and other materials Other inorganic cyanide compounds - 0.01452 g 20000 20 2658 0.2658	2 <mark>658</mark>
Underfill Solvents, additives, and other materials Proprietary Material-Other organic silicon compounds - 0.039204 g 54000 54 7176 0.7176	176
Underfill Solvents, additives, and other materials Other miscellaneous substances (less than 5%) 0.002178 g 3000 3 398 0.0398	398
Underfill Solvents, additives, and other materials Proprietary Material-Methoxysilane - 0.002178 g 3000 3 398 0.0398	1398
High Pb Bumped Semiconductor D 0.3473 15 g	
High Pb Bumped Semiconductor D Lead/Lead Compounds Lead 7439-92-1 0.03270767 g 94177 9.4177 5987 0.5987	987
High Pb Bumped Semiconductor D Nickel (external applications only) Nickel 7440-02-0 0.00028652 g 825 0.0825 52 0.0052	052
High Pb Bumped Semiconductor D Metals Tin, metal 7440-31-5 0.00172122 g 4956 0.4956 315 0.0315	315
High Pb Bumped Semiconductor D Metals Titanium, metal 7440-32-6 0.00001459 g 42 0.0042 2 0.0002	0002
High Pb Bumped Semiconductor D Solvents, additives, and other materials Other miscellaneous substances (less than 5%) 0.0031257 g 9000 0.9 572 0.0572	572
High Pb Bumped Semiconductor D Glass Silicon, doped - 0.3094443 g 891000 89.1 56648 5.6648	648

LINKS MCD LINK NXP website http://www.nxp.com GENERAL ENVIRONMENTAL COMPLIANCE LINKS http://www.nxp.com/files/corporate/doc/support\_info/NXP-ROHS-DECLARATION.pdf RoHS signed letter China RoHS http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization/china-rohs:ENV\_CHINA\_ROHS\_STRATEGY http://www.nxp.com/files/corporate/doc/support\_info/NXP-REACH-STATEMENT.pdf REACH signed letter http://www.nxp.com/files/corporate/doc/support\_info/NXP-ELV-STATEMENT.pdf ELV signed letter http://www.nxp.com/files/corporate/doc/support\_info/NXP-STATEMENT-CONFLICT-MINERALS.pdf Conflict Minerals statement NXP ENVIRONMENTAL INFORMATION Environmental Compliance website http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization:ABUENVPRFPRDX FAQ http://www.nxp.com/about/corporate-responsibility/environmental-compliance-organization/eco-product-faqs:ENVIRON\_FAQ http://www.nxp.com/support/sales-and-support:SUPPORTHOME Technical Service Request

http://www.NXP.com/files/abstract/corporate/ehs\_epp/IPC-1752-2\_v1.1\_MCD\_Template.pdf

LINKS TO BLANK IPC1752 FORMS Blank IPC1752 v1.1 Form

## IPC1752 XML LINKS

http://www.freescale.com/mcds/MC8640DTVU1000HE\_IPC1752\_v11.xml

http://www.freescale.com/mcds/MC8640DTVU1000HE\_IPC1752A.xml